



1FW B 2827

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application

Inventor: Charles A. Miller
Appln. No.: 09/970,749
Confirm. No.: 1647
Filed: October 3, 2001
Title: Multiple Die Interconnect System

PATENT APPLICATION

Art Unit: 2827
Examiner: Dinh, Tuan T.

Customer No. 23910

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

I hereby certify that this correspondence is being deposited in the United States Postal Service with sufficient postage as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on April 27, 2004.

Thomas A. Ward (Attorney Signature)
Thomas A. Ward, Reg. 35,732
Signature Date: April 27, 2004

RESPONSE TRANSMITTAL LETTER

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmitted with this communication in connection with the above-identified application are the following:

✓

A Response under 37 C.F.R. §1.111 to the Office Action dated January 27, 2004.

The fee associated with this communication has been calculated as shown below:

✓

A fee for addition of claims under 37 C.F.R. §1.16 is due as follows:

FEES	Claims Remaining After Amendment	Highest Number Previously Paid For	Present Extra	Rate Small Entity/Other Than Small Entity	Total
TOTAL CLAIMS (37 CFR 1.16(c))	<u>39</u> * -	<u>38</u> **	<u>1</u>	X \$ 9.00 X \$ 18.00	\$18.00
INDEPENDENT CLAIMS (37 CFR 1.16(b))	<u>6</u> * -	<u>4</u> ***	<u>2</u>	X \$ 43.00 X \$ 86.00	\$172.00
					TOTAL \$190.00

The total fee required with this communication is \$190.00 and is to be paid as follows:

✓

Please charge Deposit Account No. 06-1325 in the amount of \$190.00.

✓

The Commissioner is hereby authorized to charge any deficiencies or credit overpayment to Deposit Account No. 06-1325.

Respectfully submitted,

Date: 4/27/04

By: Thomas Ward

Thomas A. Ward, Reg. 35,732

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application

Inventors: Charles A. Miller

SC/Serial No.: 09/970,749

Confirm. No.: 1647

Filed: October 3, 2001

Title: MULTIPLE DIE INTERCONNECT SYSTEM

PATENT APPLICATION

Art Unit: 2827

Examiner: Dinh, Tuan T.

Customer No. 23910

RESPONSE TO OFFICE ACTION UNDER 37 C.F.R. § 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed January 27, 2004, please amend the above-identified application as follows:

In the Claims:

Please amend claims 21, 28 and 29, and add new claim 39 as indicated in the list of claims beginning on the following page.

04/30/2004 FMETEK11 00000071 061325 09970749

01 FC:1202 18.00 DA
02 FC:1201 172.00 DA